Electronic Patent Application Fee Transmittal							
Application Number:	10	10619731					
Filing Date:	15-Jul-2003						
Title of Invention:	SYSTEM AND METHOD FOR HEATING AND COOLING WAFER AT ACCELERATED RATES						
First Named Inventor/Applicant Name:	Wayne Glenn Renken						
Filer:	Katherine Alison DeRuntz/Eileen Bowen (PAG)						
Attorney Docket Number:	SENS.007US1						
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Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
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